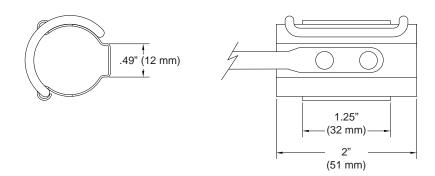




Specifications for LDF5 Series SureGround™ Grounding Kits



Characterisitics

Material

Clip Copper
Bail Stainless Steel
Rivets Copper
Lugs Tin Plated Copper

Bonding Conductor 7-Strand Copper Wire Cross-Sectional Area 16 mm²

Electrical

Parameter

Meets MIL-STD-188-124A "Military Standard for Grounding, Bonding and Shielding" bond resistance requirement of a maximum DC resistance of 0.001 Ohm's. Meets IEC 1024-1 "Protection of Structures Against Lightning" requirements of 16 mm² cross-sectional area for copper bonding conductors.

Test Method

Tested to withstand 130,000 amps peak current surge in accordance to MIL-STD-1757, Test Method T02, Current Component A, using a damped oscillatory type waveform.

Mechanical

Fits cable diameters 1.050 inches (26.7 mm) to 1.130 inches (28.7 mm)

Lug clearance holes 3/8 - 16 or M10 screws
Bail closure force Maximum of 25 lbs

Environmental

Operating Temperature -40° C to +85° C Storage Temperature -40° C to +80° C

Weather Resistant* Salt Spray, Rain, Ice, Wind, UV

Test Specification

Vibration MIL-STD-202, Method 214
Corrosion (Salt Spray) MIL-STD-1344, Method 1001
Humidity (Thermal Cycling) MIL-STD-1344, Method 1002
Solar Radiation (UV) MIL-STD-810, Method 505
Blowing Rain MIL-STD-810, Method 506
Freezing Rain/Icing MIL-STD-810, Method 521

^{*} SureGround™ is supplied with weatherproofing material which must be installed properly to insure optimum performance in these conditions.